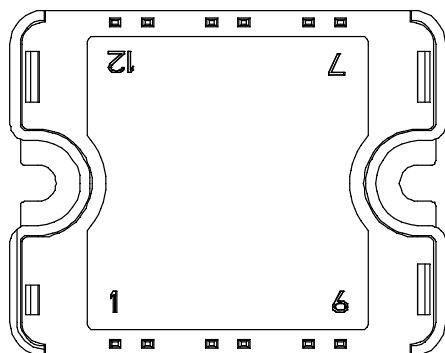
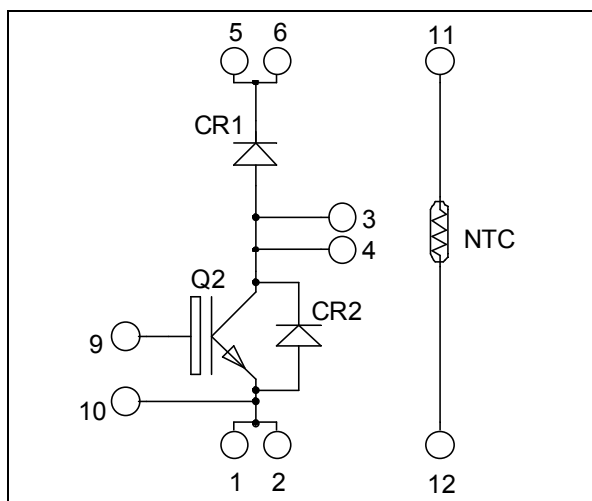


## Boost chopper NPT IGBT Power Module

$V_{CES} = 1200V$   
 $I_C = 75A @ T_c = 80^\circ C$



Pins 1/2 ; 3/4 ; 5/6 must be shorted together

### Application

- AC and DC motor control
- Switched Mode Power Supplies
- Power Factor Correction

### Features

- Non Punch Through (NPT) Fast IGBT
  - Low voltage drop
  - Low tail current
  - Switching frequency up to 50 kHz
  - Soft recovery parallel diodes
  - Low diode VF
  - Low leakage current
  - RBSOA and SCSOA rated
- Very low stray inductance
- Internal thermistor for temperature monitoring
- High level of integration

### Benefits

- Outstanding performance at high frequency operation
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Solderable terminals both for power and signal for easy PCB mounting
- Low profile
- RoHS Compliant

### Absolute maximum ratings

| Symbol    | Parameter                             | Max ratings         | Unit         |
|-----------|---------------------------------------|---------------------|--------------|
| $V_{CES}$ | Collector - Emitter Breakdown Voltage | 1200                | V            |
| $I_C$     | Continuous Collector Current          | $T_c = 25^\circ C$  | A            |
|           |                                       | $T_c = 80^\circ C$  |              |
| $I_{CM}$  | Pulsed Collector Current              | $T_c = 25^\circ C$  | 150          |
| $V_{GE}$  | Gate - Emitter Voltage                | $\pm 20$            | V            |
| $P_D$     | Maximum Power Dissipation             | $T_c = 25^\circ C$  | 500          |
| RBSOA     | Reverse Bias Safe Operating Area      | $T_j = 150^\circ C$ | 150A @ 1200V |

**CAUTION:** These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on [www.microsemi.com](http://www.microsemi.com)

**All ratings @  $T_j = 25^\circ\text{C}$  unless otherwise specified**

**Electrical Characteristics**

| Symbol        | Characteristic                       | Test Conditions                        |                                                       | Min | Typ        | Max        | Unit          |
|---------------|--------------------------------------|----------------------------------------|-------------------------------------------------------|-----|------------|------------|---------------|
| $I_{CES}$     | Zero Gate Voltage Collector Current  | $V_{GE} = 0V$<br>$V_{CE} = 1200V$      | $T_j = 25^\circ\text{C}$<br>$T_j = 125^\circ\text{C}$ |     |            | 250<br>500 | $\mu\text{A}$ |
| $V_{CE(sat)}$ | Collector Emitter saturation Voltage | $V_{GE} = 15V$<br>$I_C = 75A$          | $T_j = 25^\circ\text{C}$<br>$T_j = 125^\circ\text{C}$ |     | 3.2<br>3.9 | 3.7        | V             |
| $V_{GE(th)}$  | Gate Threshold Voltage               | $V_{GE} = V_{CE}, I_C = 2.5\text{ mA}$ |                                                       | 4.5 |            | 6.5        | V             |
| $I_{GES}$     | Gate – Emitter Leakage Current       | $V_{GE} = \pm 20V, V_{CE} = 0V$        |                                                       |     |            | $\pm 500$  | nA            |

**Dynamic Characteristics**

| Symbol       | Characteristic               | Test Conditions                                                                                                       |                           | Min | Typ | Max | Unit |
|--------------|------------------------------|-----------------------------------------------------------------------------------------------------------------------|---------------------------|-----|-----|-----|------|
| $C_{ies}$    | Input Capacitance            | $V_{GE} = 0V$                                                                                                         |                           |     | 5.1 |     | nF   |
| $C_{oes}$    | Output Capacitance           | $V_{CE} = 25V$                                                                                                        |                           |     | 0.7 |     |      |
| $C_{res}$    | Reverse Transfer Capacitance | $f = 1\text{MHz}$                                                                                                     |                           |     | 0.4 |     |      |
| $T_{d(on)}$  | Turn-on Delay Time           | Inductive Switching ( $25^\circ\text{C}$ )<br>$V_{GE} = 15V$<br>$V_{Bus} = 600V$<br>$I_C = 75A$<br>$R_G = 7.5\Omega$  |                           |     | 120 |     | ns   |
| $T_r$        | Rise Time                    |                                                                                                                       |                           |     | 50  |     |      |
| $T_{d(off)}$ | Turn-off Delay Time          |                                                                                                                       |                           |     | 310 |     |      |
| $T_f$        | Fall Time                    |                                                                                                                       |                           |     | 20  |     |      |
| $T_{d(on)}$  | Turn-on Delay Time           | Inductive Switching ( $125^\circ\text{C}$ )<br>$V_{GE} = 15V$<br>$V_{Bus} = 600V$<br>$I_C = 75A$<br>$R_G = 7.5\Omega$ |                           |     | 130 |     | ns   |
| $T_r$        | Rise Time                    |                                                                                                                       |                           |     | 60  |     |      |
| $T_{d(off)}$ | Turn-off Delay Time          |                                                                                                                       |                           |     | 360 |     |      |
| $T_f$        | Fall Time                    |                                                                                                                       |                           |     | 30  |     |      |
| $E_{on}$     | Turn-on Switching Energy     | $V_{GE} = 15V$<br>$V_{Bus} = 600V$                                                                                    | $T_j = 125^\circ\text{C}$ |     | 9   |     | mJ   |
| $E_{off}$    | Turn-off Switching Energy    | $I_C = 75A$<br>$R_G = 7.5\Omega$                                                                                      | $T_j = 125^\circ\text{C}$ |     | 4   |     |      |

**Chopper diode ratings and characteristics**

| Symbol    | Characteristic                          | Test Conditions                                            |                                                       | Min  | Typ             | Max        | Unit          |
|-----------|-----------------------------------------|------------------------------------------------------------|-------------------------------------------------------|------|-----------------|------------|---------------|
| $V_{RRM}$ | Maximum Peak Repetitive Reverse Voltage |                                                            |                                                       | 1200 |                 |            | V             |
| $I_{RM}$  | Maximum Reverse Leakage Current         | $V_R = 1200V$                                              | $T_j = 25^\circ\text{C}$<br>$T_j = 125^\circ\text{C}$ |      |                 | 100<br>500 | $\mu\text{A}$ |
| $I_F$     | DC Forward Current                      |                                                            | $T_c = 70^\circ\text{C}$                              |      | 60              |            | A             |
| $V_F$     | Diode Forward Voltage                   | $I_F = 60A$<br>$I_F = 120A$<br>$I_F = 60A$                 | $T_j = 125^\circ\text{C}$                             |      | 2.5<br>3<br>1.8 | 3          | V             |
| $t_{rr}$  | Reverse Recovery Time                   | $I_F = 100A$<br>$V_R = 800V$<br>$di/dt = 200A/\mu\text{s}$ | $T_j = 25^\circ\text{C}$<br>$T_j = 125^\circ\text{C}$ |      | 265<br>350      |            | ns            |
| $Q_{rr}$  | Reverse Recovery Charge                 |                                                            | $T_j = 25^\circ\text{C}$<br>$T_j = 125^\circ\text{C}$ |      | 560<br>2890     |            | nC            |

**Thermal and package characteristics**

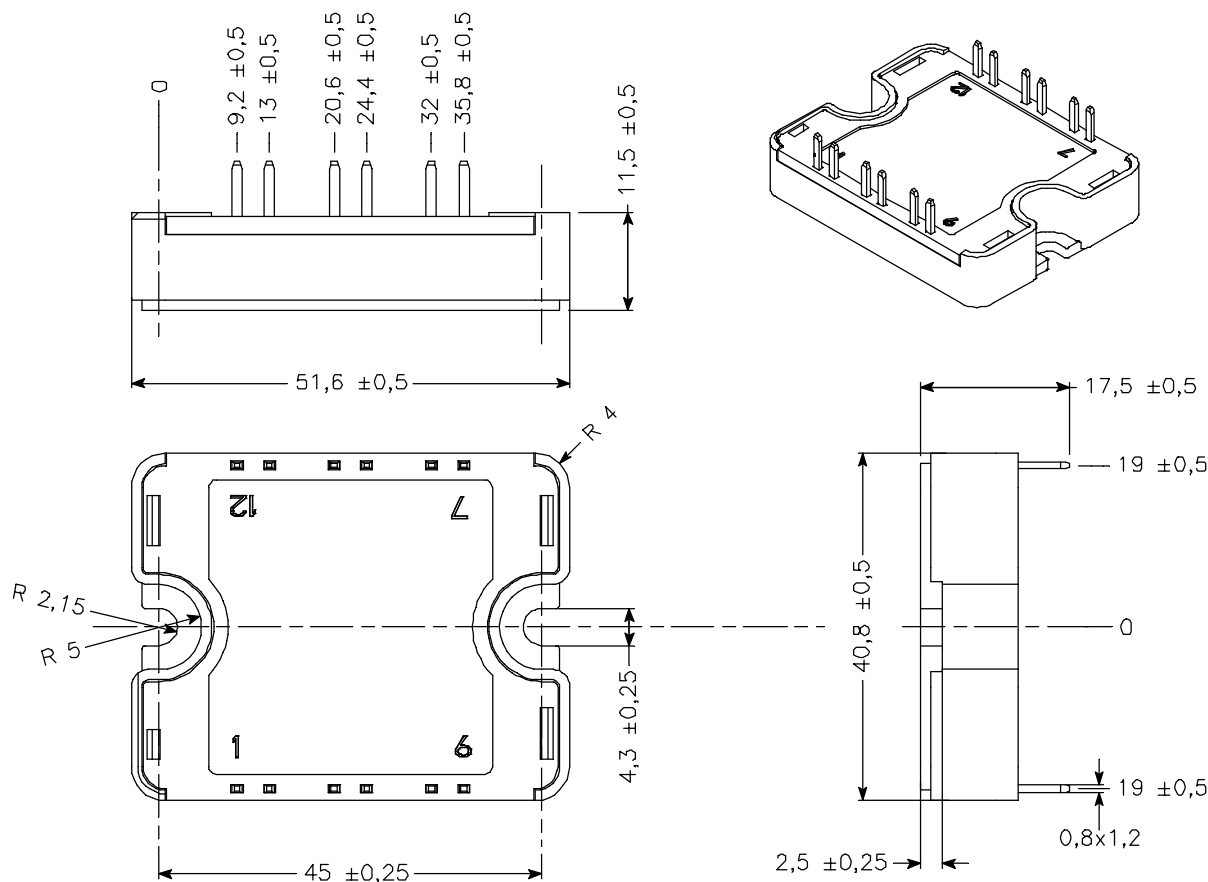
| Symbol            | Characteristic                                                           |             |    | Min   | Typ | Max  | Unit |
|-------------------|--------------------------------------------------------------------------|-------------|----|-------|-----|------|------|
| R <sub>thJC</sub> | Junction to Case Thermal Resistance                                      |             |    | IGBT  |     | 0.25 | °C/W |
|                   |                                                                          |             |    | Diode |     | 0.9  |      |
| V <sub>ISOL</sub> | RMS Isolation Voltage, any terminal to case t=1 min, I isol<1mA, 50/60Hz |             |    | 2500  |     |      | V    |
| T <sub>J</sub>    | Operating junction temperature range                                     |             |    | -40   |     | 150  | °C   |
| T <sub>STG</sub>  | Storage Temperature Range                                                |             |    | -40   |     | 125  |      |
| T <sub>C</sub>    | Operating Case Temperature                                               |             |    | -40   |     | 100  |      |
| Torque            | Mounting torque                                                          | To heatsink | M4 | 2.5   |     | 4.7  | N.m  |
| Wt                | Package Weight                                                           |             |    |       |     | 80   | g    |

**Temperature sensor NTC** (see application note APT0406 on www.microsemi.com for more information).

| Symbol             | Characteristic             | Min | Typ  | Max | Unit |
|--------------------|----------------------------|-----|------|-----|------|
| R <sub>25</sub>    | Resistance @ 25°C          |     | 50   |     | kΩ   |
| B <sub>25/85</sub> | T <sub>25</sub> = 298.15 K |     | 3952 |     | K    |

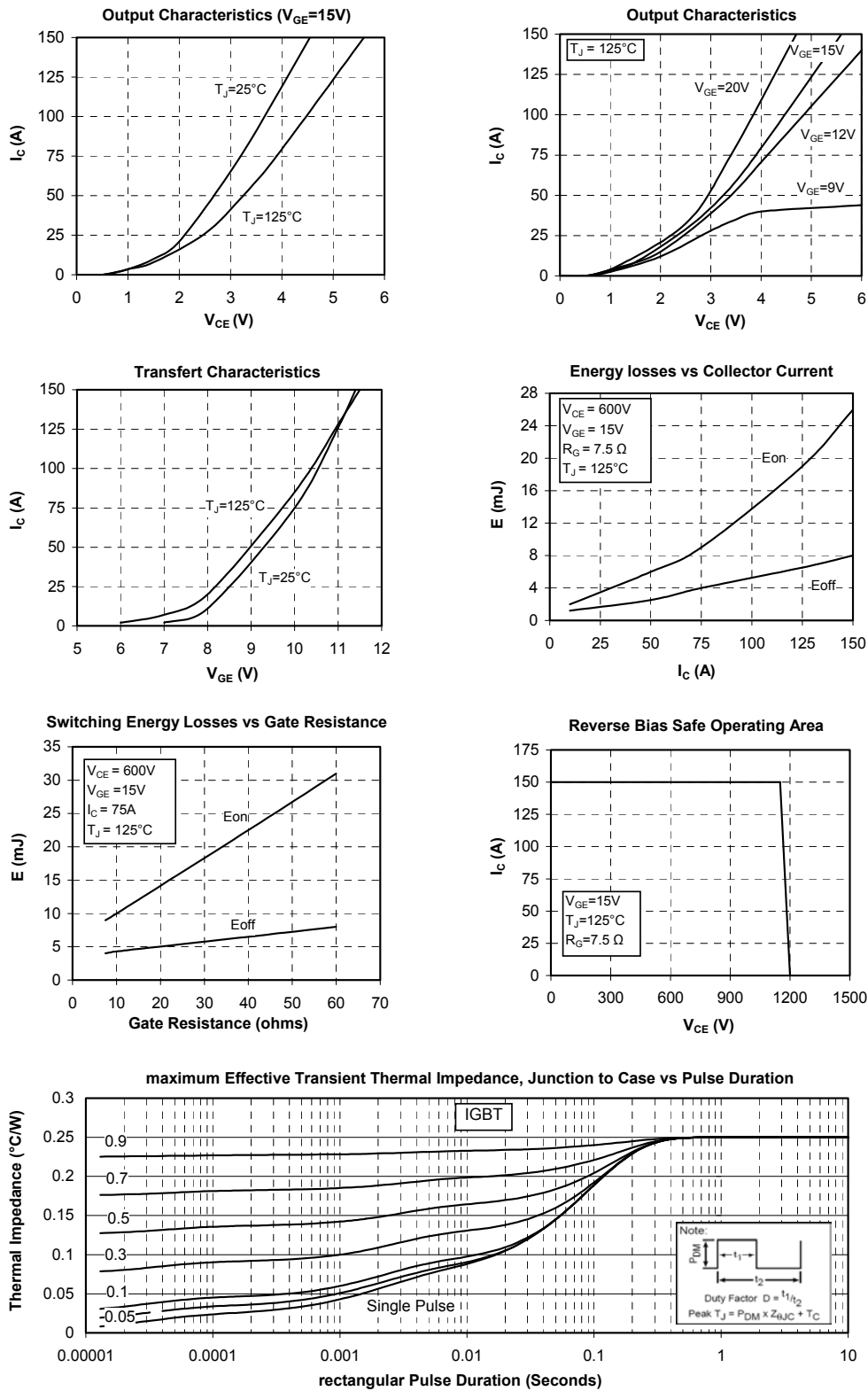
$$R_T = \frac{R_{25}}{\exp \left[ B_{25/85} \left( \frac{1}{T_{25}} - \frac{1}{T} \right) \right]}$$

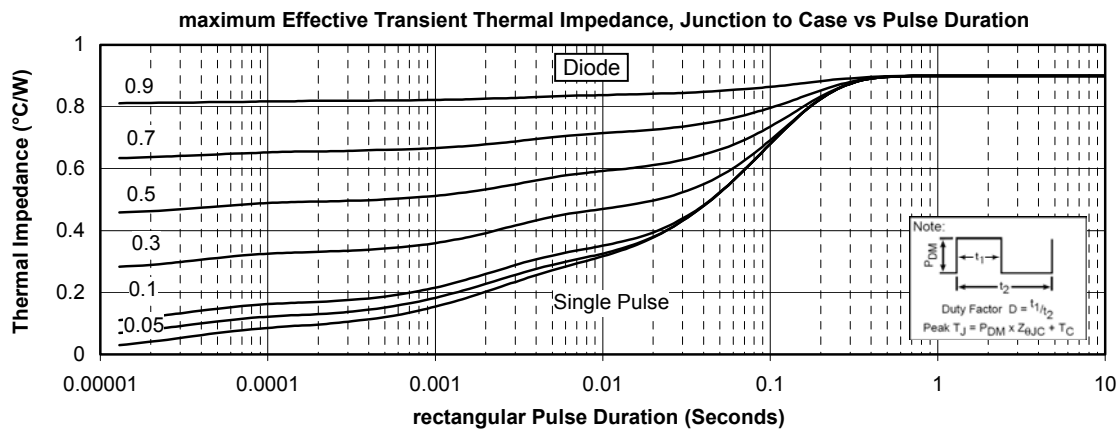
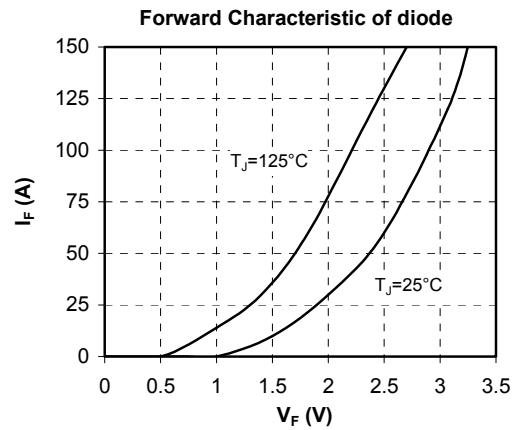
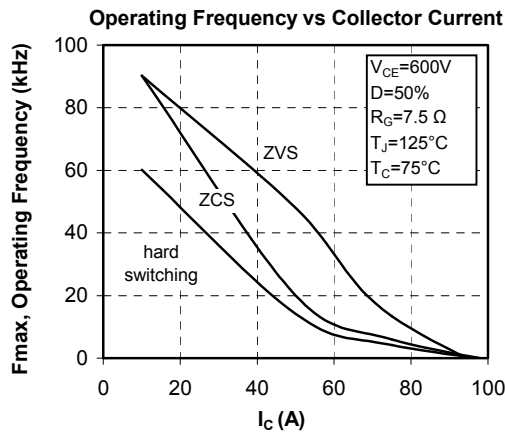
T: Thermistor temperature  
 R<sub>T</sub>: Thermistor value at T

**SP1 Package outline** (dimensions in mm)


See application note 1904 - Mounting Instructions for SP1 Power Modules on [www.microsemi.com](http://www.microsemi.com)

## Typical Performance Curve





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